

25% glass bead filled for stiffness, low warpage

Celcon® GB25 acetal copolymer is a 25% glass bead filled grade for low shrinkage and warp resistance in large, flat and thin walled parts.

Chemical abbreviation according to ISO 1043-1: POM

### **Rheological properties**

Melt volume-flow rate Melt mass-flow rate Temperature Load Melt mass-flow rate, Temperature Melt mass-flow rate, Load		kg °C	ISO 1133 ISO 1133
Moulding shrinkage range, parallel	1.5	-	ISO 294-4, 2577
Moulding shrinkage range, normal	1.3	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile Modulus		MPa	ISO 527-1/-2
Yield stress, 50mm/min		MPa	ISO 527-1/-2
Yield strain, 50mm/min		%	ISO 527-1/-2
Flexural Modulus		MPa	ISO 178
Compressive stress at 1% strain		MPa	ISO 604
Charpy notched impact strength, 23°C		kJ/m <sup>2</sup>	ISO 179/1eA
Charpy notched impact strength, -30°C Izod notched impact strength, 23°C		kJ/m² kJ/m²	ISO 179/1eA ISO 180/1A
Poisson's ratio	2.0 0.422		150 180/1A
1015501151410	0.422		
Thermal properties			
Melting temperature, 10°C/min	165	°C	ISO 11357-1/-3
Temp. of deflection under load, 1.8 MPa	105		ISO 75-1/-2
Vicat softening temperature, 50°C/h, 50N	161		ISO 306
Coeff. of linear therm. expansion, parallel		E-6/K	ISO 11359-1/-2
Coeff. of linear therm. expansion, normal	80	E-6/K	ISO 11359-1/-2
Other properties			
Humidity absorption, 2mm	0.2	%	Sim. to ISO 62
Water absorption, 2mm	0.65	%	Sim. to ISO 62
Density	1580	kg/m³	ISO 1183

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Page: 1 of 7





#### Injection

Drying Temperature	100 - 120 °C
Drying Time, Dehumidified Dryer	3-4 h
Melt Temperature Optimum	174 °C
Max. mould temperature	90 - 120 °C
Back pressure	2 MPa
Injection speed	slow

Internal

#### Additional information

Injection molding

Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.

Melt Temperature: Preferred range 182-199 C (360-390 F). Melt temperature should never exceed 230 C (450 F).

Mold Surface Temperature: Preferred range 82-93 C (180-200 F) especially with wall thickness less than 1.5 mm (0.060 in.). May require mold temperature as high as 120 C (250 F) to reproduce mold surface or to assure minimal molded in stress. Wall thickness greater than 3mm (1/8 in.) may use a cooler (65 C/150 F) mold surface temperature and wall thickness over 6mm (1/4 in.) may use a cold mold surface down to 25 C (80 F). In general, mold surface temperatures lower than 82 C (180 F) may hinder weld line formation and produce a hazy surface or a surface with flow lines, pits and other included defects that can hinder part performance.

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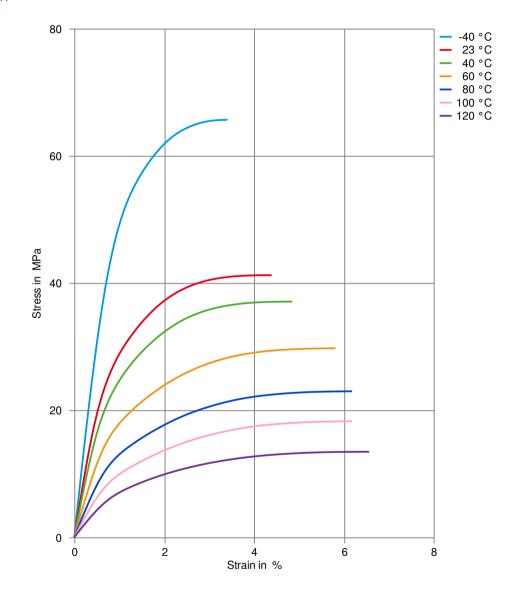


Page: 2 of 7





#### Stress-strain



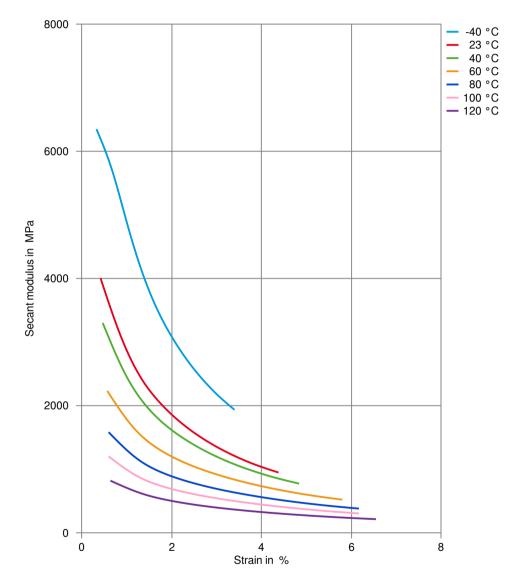


Page: 3 of 7





### Secant modulus-strain



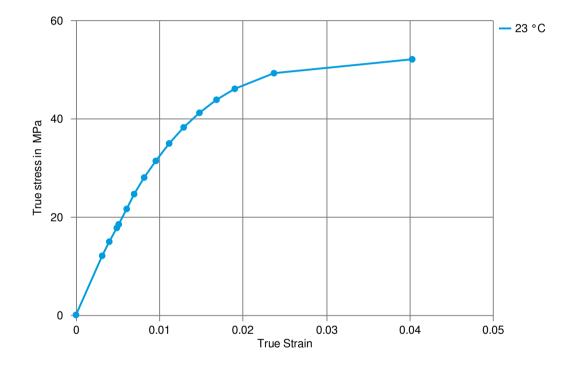


Page: 4 of 7





#### True stress-strain



Printed: 2023-09-15



Page: 5 of 7





Processing Texts			
Pre-drying	Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be necessary to prevent splay and odor problems.		
Injection molding	Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.		
	Melt Temperature: Preferred range 182-1 should never exceed 230 C (450 F).	199 C (360-390 F). Melt temperature	
	Mold Surface Temperature: Preferred range 82-93 C (180-200 F) especially with wall thickness less than 1.5 mm (0.060 in.). May require mold temperature as high as 120 C (250 F) to reproduce mold surface or to assure minimal molded in stress. Wall thickness greater than 3mm (1/8 in.) may use a cooler (65 C/150 F) mold surface temperature and wall thickness over 6mm (1/4 in.) may use a cold mold surface down to 25 C (80 F). In general, mold surface temperatures lower than 82 C (180 F) may hinder weld line formation and produce a hazy surface or a surface with flow lines, pits and other included defects that can hinder part performance.		
Injection molding Preprocessing	Drying is generally not required because Celcon® and Hostaform® acetal copolymers are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can lead to splay (silver streaking) in molded parts. For better uniformity in molding especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying conditions are 80 C (180 F) for 3hours. Desiccant hopper dryers are not required. Maximum water content = $0.35\%$		
Injection molding Postprocessing	Postprocessing conditioning and moisturizing are not required. It may be necessary to fixture large or complicated parts with varying wall thickness to prevent warpage while cooling to ambient temperature.		
Other Approvals			
Other Approvals	OEM	Specification	
	Stellantis - Chrysler	CPN 4165	
	Ford	WSB-M4D821-A	

Printed: 2023-09-15



Page: 6 of 7

